Dopant imaging of Si and SiC structures using different SPM methods

Urs Gysin 1, Thilo Glatzel 1, Ernst Meyer 1, Aleksey Mikhaylov 2, Sergey Reshanov 2, Adolf Schöner 2 and Holger Bartolf 3

1 Departement Physik, Universität Basel, Klingelbergstrasse 82, CH-4056 Basel
2 Ascatron AB, Electrum 207, SE–16440 Kista, Sweden
3 Power Semiconductors, ABB Corporate Research Center, Segelhofstrasse 1K, CH-5405 Baden-Dättwil

Motivation

Power semiconductor devices are key elements in power converters required for transportation of electrical power over long distances, e.g. from offshore wind parks to consumers ashore.

To enable an improved energy efficient design of the power semiconducting devices, a better understanding of the nano scaled implantation, activation and diffusion processes is indispensable. Therefore dopant concentrations of semiconducting devices made of silicon (Si) and silicon carbide (SiC) are imaged and analysed using different scanning probe microscopy (SPM) methods.

SPM Methods & Instrumental Setup

Several scanning probe microscopy techniques are adapted for dopant imaging.

Kelvin Probe Force Microscopy (KPFM). The contact potential difference $V_{\text{CPD}}$ is obtained by nullifying the force acting on the 2nd eigenmode of the cantilever.

Scanning Capacitance Force Microscopy (SCFM). The derivative of the capacitance with respect to the voltage is measured as a force acting on the 2nd eigenmode of the cantilever.

Scanning Spreading Resistance Microscopy (SSRM). The resistance of the probe sample interface is measured with a logarithmic amplifier.

Home built Atomic Force Microscope operated in Ultra High Vacuum at ambient temperature.

Measurements & Results

Measurements on n-doped SiC calibrations layers. (a) schematic view, (b) KPFM with laser illumination ($\lambda=475-525$ nm), (c) 1st (d) 2nd and (e) 3rd harmonic of the periodic force. (f) a SSRM image.

Surface photovoltage (SPV) effect shown on a SiC pn-junction. (a) topography, (b) dark KPFM, (c) laser illuminated KPFM ($\lambda=470-480$ nm) and (d) profiles for different laser power intensities.

Conclusion & Outlook

Several scanning probe microscopy methods allow to image dopant profiles in a range from $10^{14}$ cm$^{-3}$ to $10^{19}$ cm$^{-3}$ in silicon (Si) and silicon carbide (SiC) structures. From SSRM analysis dopant concentration maps are calculated using calibration layers with known dopant concentration. SSRM is a rather stable method for dopant imaging and the calibration layers are easily visible. Unfortunately the samples are severely damaged after measurement as the diamond tip of the cantilever scratches them.

For the non contact SPM techniques like KPFM and SCFM sample preparation is crucial to visualize the calibration layers, but they have the advantage of being non-destructive. In future we will focus on spectroscopy measurements with different electrostatic force microscope methods.